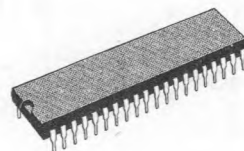


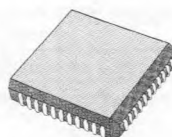
MULTI MODE MODEM ANALOG FRONT-END

ADVANCE DATA

- 12 BIT A/D AND D/A CONVERTERS WITH PROGRAMMABLE SAMPLING FREQUENCY : 7.2, 8.0, OR 9.6 kHz
- 6 TH ORDER SWITCHED CAPACITOR TRANSMIT FILTER
- TRANSMIT ATTENUATOR PROGRAMMABLE FROM 0 dB TO 22 dB WITH 2 dB STEP
- DUPLEXER OUTPUT AVAILABLE WITH PROGRAMMABLE ATTENUATION
- 15 TH ORDER SWITCHED CAPACITOR Rx FILTER (PROGRAMMABLE)
- TWO PROGRAMMABLE GAIN Rx AMPLIFIERS : FROM 0 dB TO 9 dB WITH 3 dB STEP BEFORE Rx FILTER AND FROM 0 dB TO 46.5 dB WITH 1.5 dB STEP AFTER Rx FILTER
- PROGRAMMABLE CARRIER LEVEL DETECTOR
- ON CHIP ANTI-ALIASING CELLS (TRANSMIT AND RECEIVE)
- TWO INDEPENDANT TRANSMIT AND RECEIVE DIGITAL PHASE LOCKED LOOPS (DPLLs)
- TERMINAL CLOCK INPUT FOR TRANSMIT SYNCHRONIZATION
- THREE AVAILABLE OUTPUT CLOCKS : BIT, BAUD AND CONVERSION CLOCKS
- DSP INTERFACE THROUGH 8 BIT STANDARD BUS FOR BOTH SIGNAL SAMPLES AND CONTROL REGISTER ACCESS
- AUTOMATIC RESET ON POWER-ON
- ± 5 V POWER SUPPLY
- 250 mW TYPICAL POWER CONSUMPTION



P
DIP40
(Plastic Package)



FN
PLCC44
(Plastic Package)

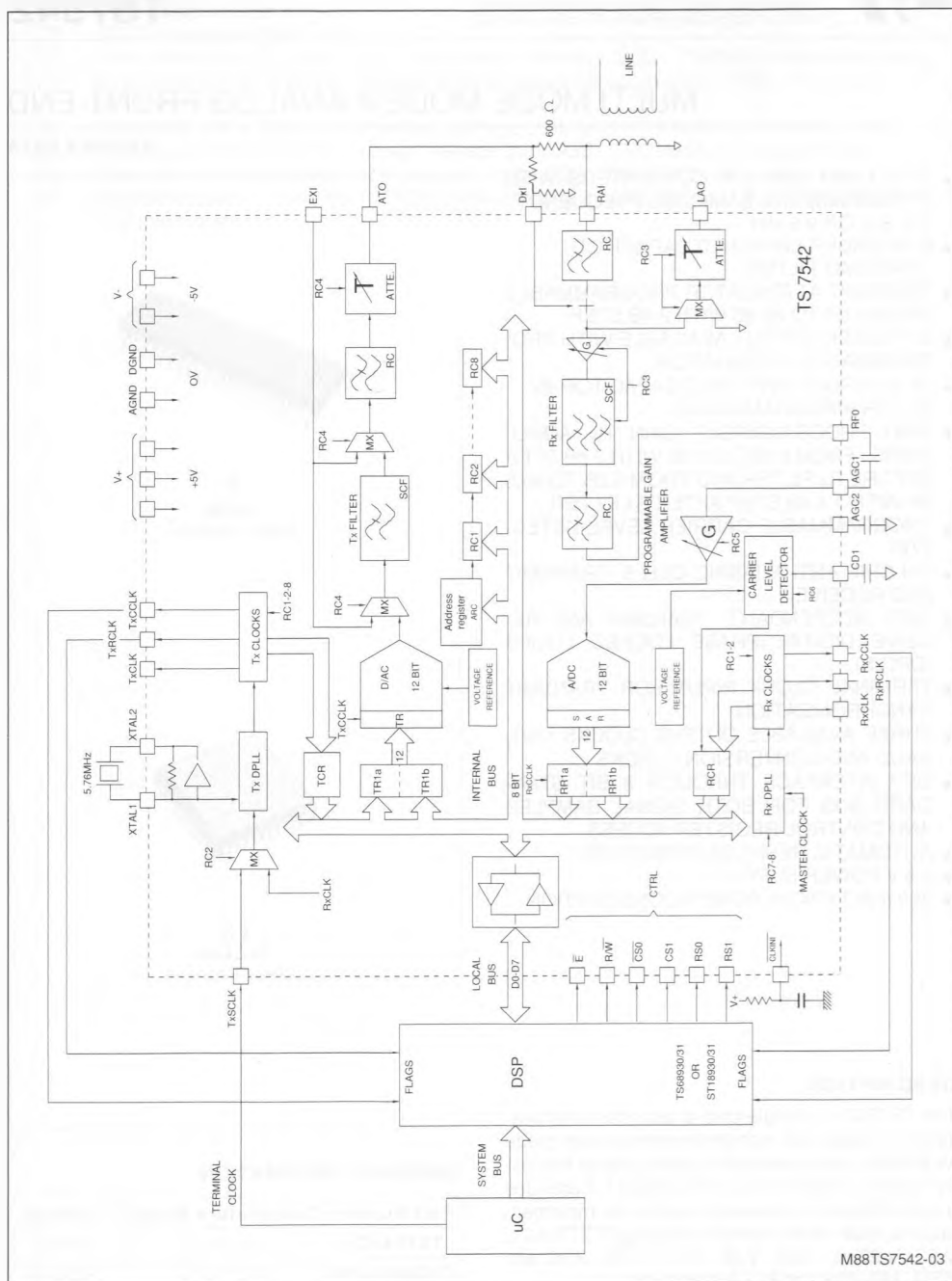
DESCRIPTION

The TS7542 is a single-chip analog front-end designed to implement high-performance voice-grade MODEMS. Associated with a Digital Signal Processor such as TS68930/31 or ST18930/31, it provides a cost-effective and powerful solution for implementation of multi-mode modems including CCITT V.21, V.22, V.22bis, V.23, V.26, V.27, V.29, V.33 and BELL 103, 202 and 212 A standards.

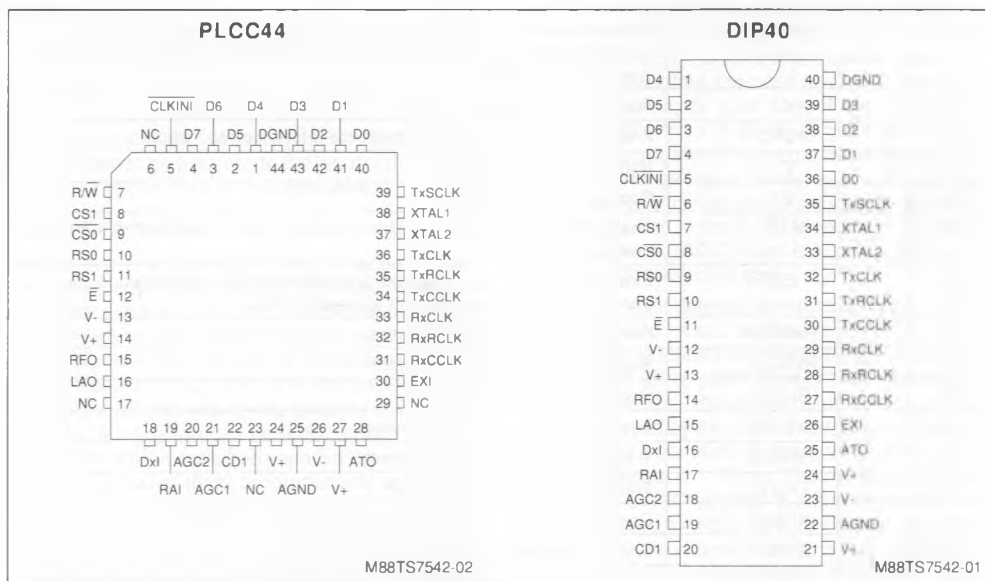
ORDERING INFORMATION

Part Number	Temperature Range	Package
TS7542CP	0 to 70 °C	DIP 40
TS7542CFN	0 to 70 °C	PLCC 44

BLOCK DIAGRAM



PIN CONNECTIONS



PIN DESCRIPTION

N°	Name	Description
1-4	D4-D7	Bidirectional Data Bus
5	CLKINI	Clock Initialization Input. Must be tied to V ⁺ during normal operation.
6	R/W	Read/Write Selection Input. This input indicates whether the current bus cycle is a read (high) or write (low) cycle.
7-8	CS1-CS0	Chip Select Inputs. The chip is selected when CS0 = 0 and CS1 = 1.
9-10	RS0-RS1	Register Select Inputs. Select the register involved in a read or write operation.
11	E	Enable Input. Enables selection inputs. Active on a low level for read operation. Active on a positive-going edge for write operation.
12	V ⁻	Negative Supply Voltage. V ⁻ = -5 V ± 5 %
13	V ⁺	Positive Supply Voltage. V ⁺ = +5 V ± 5 %
14	RFO	Receive Filter Analog Output. Designed to be connected to AGC1 input through a 1µF non polarized capacitor.
15	LAO	Line Attenuator Output. Duplexer analog output useful for line monitoring during call progress.
16	Dxl	Duplexer Input. Signal on that analog input will be subtracted from the receive anti-aliasing filter output to implement duplexer function.
17	RAI	Receive Analog Input. Analog input tied to the transmission line.
18	AGC2	This pin must be connected to the analog ground through a 1µF non polarized capacitor, in order to cancel the offset voltage of the AGC amplifier.
19	AGC1	Analog input of the AGC amplifier and of the carrier level detector.

PIN DESCRIPTION (continued)

20	CD1	This pin must be connected to the analog ground through a 1 μ F non polarized capacitor, in order to remove the offset voltage of the carrier level detector amplifier.
21	V ⁺	Positive Power Supply Voltage
22	AGND	Analog Ground. All analog signals are referenced to this pin.
23	V ⁻	Negative Supply Voltage
24	V ⁺	Positive Supply Voltage
25	ATO	Analog Transmit Output. Capable of driving 1200 Ω load with 5 V peak to peak amplitude.
26	EXI	External Transmit Input. Can be programmed to be connected to the transmit filter or to the transmit attenuator input.
27	RxCCLK	Receive Conversion Clock Output
28	RxRCLK	Receive Baud Rate Clock Output
29	RxCLK	Receive Bit Rate Clock Output
30	TxCCLK	Transmit Conversion Clock Output
31	TxRCLK	Transmit Baud Rate Clock Output
32	TxCLK	Transmit Bit Rate Clock Output
33	XTAL2	Crystal Oscillator Output. Nominal Frequency = 5.76 MHz.
34	XTAL1	Crystal Oscillator or External Master Clock Input
35	TxSCLK	Transmit Synchronization Clock Input. Can be connected to an external terminal clock to phase lock the internal transmit clocks. When this pin is tied to a permanent logical level the transmit DPLL free-runs or can be phase locked on the receive clock system.
36-39	D0-D3	Bidirectional Data Bus
40	DGND	Digital Ground. All digital signals are referenced to this pin.

FUNCTIONAL DESCRIPTION

The TS7542 is generally used in conjunction with a DSP to realize the "data-pump" function of a high-speed modem. The circuit communicates with the DSP via an 8-bit bidirectional bus and mainly includes the following functions :

- the transmit analog channel with the D/A Converter, the transmit filter and the transmit attenuator.
- the receive analog channel with the local echo subtractor, the receive filter, the AGC amplifier, the A/D converter and the carrier level detector.
- the two independent transmit and receive clock generators using Digital Phase Locked Loops (DPLL).
- the 15 registers used to store the 12-bit transmit and receive digital samples, digital information for the DSP like the clock and the carrier level detector status, and the data needed to control the programmable functions or to synchronize the DPLLS.

TRANSMIT CHANNEL

The transmit channel converts the digital transmit signal coming from the DSP into the analog signal to be transmitted on the phone line. It includes a 12 bit digital to analog converter (DAC) operating at 7200, 8000 or 9600 samples per second according to the supported standard and the signal processing compromises made in the DSP. The maximum analog output signal amplitude is 5 V peak to peak, defined by the internal ± 2.5 V voltage reference. The DAC is monotonic and provides a guaranteed integral linearity better than 9 bit.

The transmit filter is a 6th order low-pass switched capacitor filter (SCF) sampled at 288 kHz, whose cut-off frequency is 3.2 kHz. As the Sin x/x correction depends on the DAC sampling frequency, it has not been included in the transmit filter and must be performed by the DSP. The transmit filter is followed by a second order, continuous time low-pass filter

that removes the residual high frequency parasitic signals.

The transmit attenuator allows the transmit signal gain to be programmed from 0 dB to - 22 dB with 2 dB steps. Infinite attenuation is also programmable. The output amplifier can directly drive a 1200 Ω load. For special applications, the EXI input can be programmed to give access to the input of the transmit filter or to the input of the attenuator.

RECEIVE CHANNEL

The receive channel begins with a second order continuous time anti-aliasing filter followed by a subtractor used to implement the two-wire to four-wire conversion with few external components. The receive signal is then directed to the receive filter input and also, after programmable attenuation, to the LAO output for line monitoring purpose during call progress. Attenuation can be 0 dB, 6 dB, 12 dB or infinite. The receive switched capacitor bandpass filter is composed of three programmable sections : A 5th order low-pass section, a 4th order optional 1800 Hz notch section and a 6th order high-pass section. It also includes an input pre-filtering gain programmable from 0 dB to 9 dB with 3 dB steps. This feature is useful to optimize the dynamic range of the signal by setting the maximum receive level value close to 5 V peak to peak. The transfer function of the receive low-pass and high-pass filter sections can be translated by changing their sampling clock frequencies to support different communication standards. Ten modes are programmable to comply with CCITT V.21, V.22, V.22 bis, V.23, V.26,

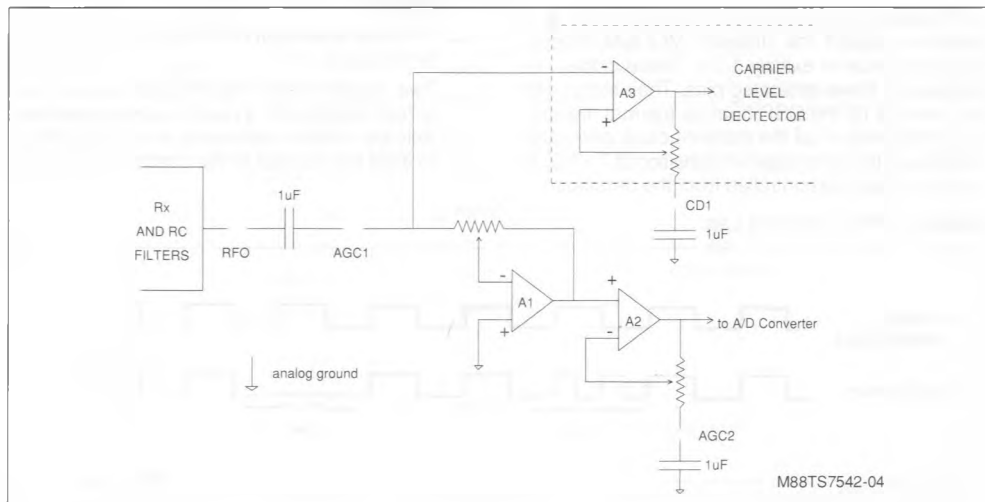
V.27, V.29 or V.33 as well as BELL 103, 202 or 212A. The typical curves obtained are given in the TRANSMISSION CHARACTERISTICS section of the data sheet. The receive filter output is smoothed in a continuous time low-pass filter and then directed to the automatic gain control (AGC) amplifier programmable from 0 dB to 46.5 dB with 1.5 dB steps. The same signal is also connected to the carrier level detector input. Three external capacitors are needed to eliminate the offset voltage as indicated in Fig.1. The residual DC level at the analog to digital converter (ADC) input is kept low and independent of the selected gain.

The carrier level detector performs the comparison between the full wave rectified receive signal and programmable threshold voltage nominally equivalent to - 45.5 dBm, - 34.4 dBm or -28.6dBm with a 2.5 dB hysteresis. The binary result of the comparison can be read by the DSP. The nominal response time of the carrier level detector to a signal settlement or removal is 1.78 ms. The receive signal delivered by the AGC amplifier is sampled and converted from analog to digital by a 12-bit monotonic A/D converter whose integral linearity is guaranteed better than 9 bit. The sampling frequency is the same as that programmed for the transmit DAC i.e. 7200, 8000, or 9600 samples per second.

CLOCK GENERATION

The 5.76 MHz master clock is obtained from either a crystal tied between XTAL1 and XTAL2 pins or an external generator connected to the XTAL1 pin. In the latter case the XTAL2 pin should be left open.

Figure 1 : AGC and Carrier Level Detector Amplifier Structure.



To meet the CCITT recommendation, the frequency tolerance requirement of the master clock must be better than ± 100 ppm. The different transmit (Tx) and receive (Rx) clocks are derived from the master clock via two independent digital phase locked loops (DPLL).

TRANSMIT CLOCKS

As shown in Fig.2 the transmit DPLL operates by adding or subtracting pulses to a 2.88 MHz internal clock at a rate of 600 Hz. Consequently the frequency capture range equals $\pm 600 \text{ Hz}/2.88 \text{ MHz}$, i.e. ± 208 ppm, a value consistent with the worst case synchronization of two independent signals having ± 100 ppm of frequency accuracy. When V.27 clocks are selected, the DPLL up-dating rate is increased to 800 Hz which is a submultiple of the 1600 baud rate of that particular mode. In this case the frequency capture range is ± 278 ppm.

The transmit DPLL can be synchronized on an external terminal clock connected to the TxSCLK input or on the receive bit clock R x CLK internally generated from the receive DPLL. It can also free-run without any phase shift.

The TS7542 delivers three synchronous transmit clocks :

- a bit clock T x CLK whose frequency equals the bit rate of the MODEM
- a baud clock T x RCLK whose frequency equals the baud rate of the MODEM
- a conversion clock T x CCLK that gives the sampling frequency of the transmit D/A converter

The frequencies of these three clocks are programmable to support the different MODEM modes. Their duty cycle is exactly 1 : 2. These clocks are available on three dedicated pins. Their status can also be read by the DSP from an internal register, TCR. Resetting of all the transmit clock generator counters on the next negative transition of T x SCLK or R x CLK can be controlled from the data bus.

Figure 2 : DPLL Lead and Lag.

RECEIVE CLOCKS

The receive DPLL phase shifts are performed in two ways :

- a coarse phase lag is obtained by suppressing several 5.76 MHz master clock pulses from the input of the receive clock generator under the control of the DSP. The number of suppressed pulses is programmable from 20 to 4800 with a step value of 20 or 300. That feature will be used to quickly synchronize the receive DPLL on the recovered receive rate.
- a fine phase lead or lag is obtained by adding or suppressing two master clock pulses from the receive clock generator input, like for the transmit DPLL. But in that case the shifts are controlled by the DSP that also implements the phase comparator of the phase locked loop.

The TS7542 delivers three receive clocks with the same nominal frequency values as their transmit counterparts :

- a bit clock R x CCLK
- a baud clock R x RCLK
- a conversion clock R x CCLK

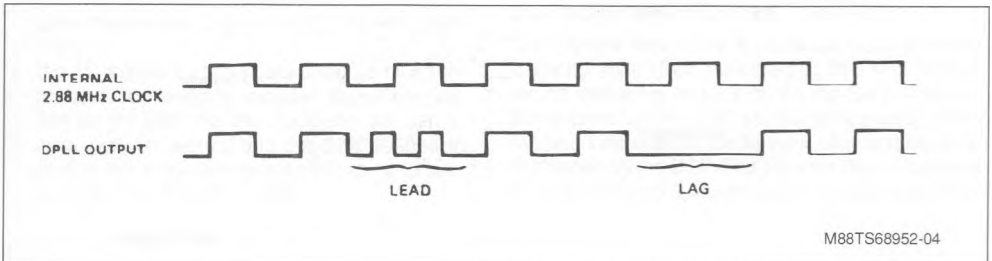
The status of these clocks can also be read from an internal register, RCR.

The receive and transmit clocks are plesiochronous.

INTERNAL REGISTERS

The 8-bit bidirectional data bus allows to access 15 internal registers as detailed in Fig.3. The data transfers are controlled by the six following signals :

- two chip select inputs $\overline{\text{CS0}}$ and CS1 that must be put respectively to 0 and 1 to allow a data transfer.
- The read/write input $\overline{\text{R/W}}$ that defines the transfer direction
- Two register select input that address one out of four registers for a read or a write operation. Actually indirect addressing is used to extend to eight the number of the control registers.



- The enable input $\bar{E}$ that strobes on its positive going transition the data to be written, or that enables on its low level state the output buffers when a data is to be read from a register.

The timing diagram of the data transfers is given in the TIMING SPECIFICATIONS section of the data sheet.

The four registers only accessible in a write operation are :

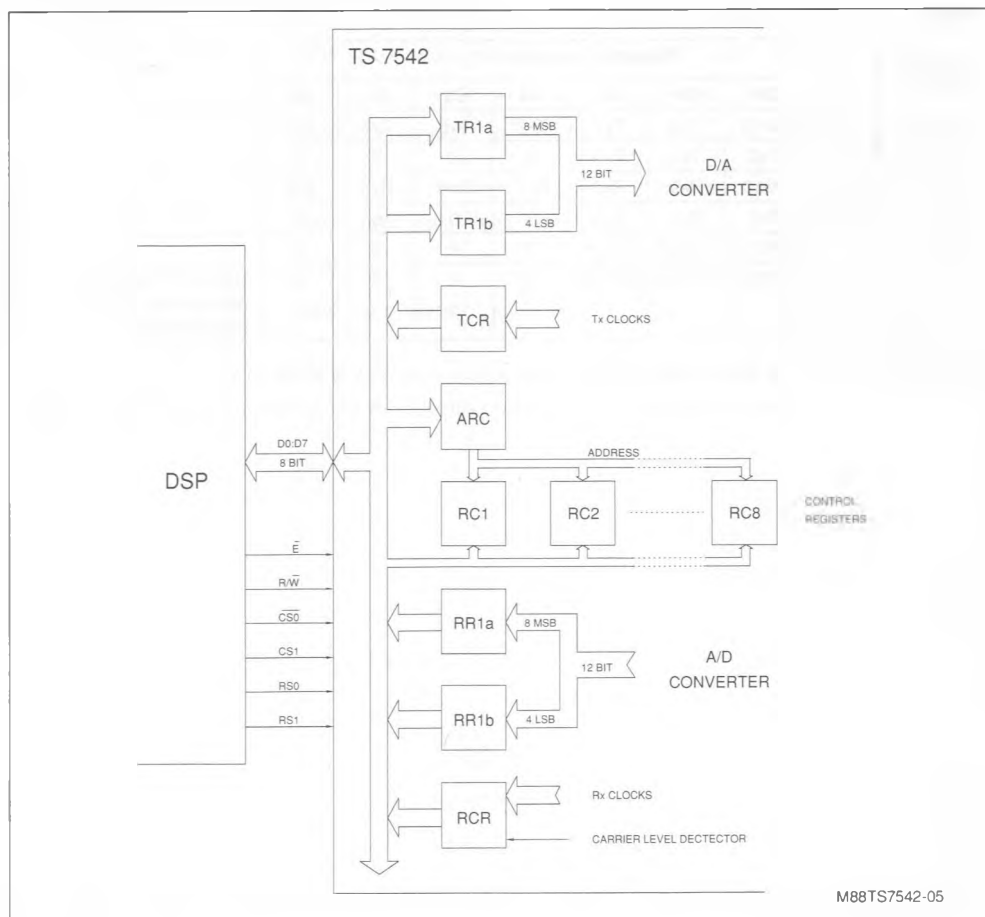
- TR1a that stores the 8 most significant bit (MSB) of the 12-bit transmit signal digital samples.
- TR1b that stores the 4 least significant bit (LSB) of the transmit signal digital samples.
- ARC that stores the 3-bit address of one out of eight control registers.

- The control register whose address is stored in the ARC register. The content of ARC is automatically incremented after each access to a control register. This allows cyclical access to these registers.

The four registers only accessible in a read operation are :

- RR1a that stores the 8 MSB of the 12-bit receive signal digital samples
- RR1b that stores the 4 LSB of the 12-bit receive signal digital samples
- RCR that stores the receive clock and the carrier level detector status
- TCR that stores the transmit clock status

Figure 3 : Internal Registers Configuration.



The addresses of the internal registers are given in table 1. Table 2 shows the formats used for the digital signal samples stored in the TR1a/b registers, the RR1a/b registers and for the status data stored

in the TCR and RCR registers. Table 3 summarizes the address and data format of the 8 control registers whose function is detailed in the PROGRAMMABLE FUNCTIONS section.

Table 1.

R/W	RS0	RS1	Accessed Register	Comment
0	0	0	TR1b	Write Only Registers
0	0	1	TR1a	
0	1	0	ARC	
0	1	1	The Control Register Addressed by ARC	
1	0	0	RR1b	Read Only Registers
1	0	1	RR1a	
1	1	0	RCR	
1	1	1	TCR	

Table 2.

Register Name	Register Content (note 1)								Comment
	D7	D6	D5	D4	D3	D2	D1	D0	
TR1a	Tx11	Tx10	Tx9	Tx8	Tx7	Tx6	Tx5	Tx4	
TR1b	Tx3	Tx2	Tx1	Tx0	X	X	X	X	
RR1a	Rx11	Rx10	Rx9	Rx8	Rx7	Rx6	Rx5	Rx4	
RR1b	Rx3	Rx2	Rx1	Rx0	0	0	0	0	
TCR	X	TxRCLK	TxCCLK	TxCCLK	X	X	X	X	
RCR	CDL	RxRCLK	RxCCLK	RxCCLK	X	X	X	X	CDL = 1 if Rx signal is greater than the programmed level.

X = Don't care.

Note 1 : D0 to D7 refer to the data bus pins and gives the bit position in the read or written data

Table 3.

Control Register Name	ARC Content (address) (note 1)			Register Content (note 2)								Programmed Function
	D7	D6	D5	D7	D6	D5	D4	D3	D2	D1	D0	
RC1	0	0	0	HB3	HB2	HB1	HR2	HR1	X	X	X	Bit/Baud Rate for Tx and Rx Clocks
RC2	0	0	1	X	X	X	HS2	HS1	HTHR	FCLK	X	Conversion Frequency. Tx Synchronization Selection
RC3	0	1	0	RF3	RF2	RF1	REJ	RFG2	RFG1	LAT2	LAT1	Rx Filter and 1800Hz Notch. LAO Attenuation
RC4	0	1	1	ATT4	ATT3	ATT2	ATT1	X	EM2	EM1	X	Tx Attenuation. EXI Input.
RC5	1	0	0	RG5	RG4	RG3	RG2	RG1	X	X	X	AGC Amplifier Gain
RC6	1	0	1	CDG2	CDG1	CDH	X	X	X	X	X	Carrier Level Detector Gain and Hysteresis
RC7	1	1	0	SP5	SP4	SP3	SP2	SP1	X	X	X	RxDPLL Coarse Phase Shift
RC8	1	1	1	MPE	SPR	AVRE	VAL	X	X	X	X	TxDPLL Reset. Rx DPLL Fine Phase Shifts.

X = Don't care value.

Note 2 : D0 to D7 refers to the data bus pins and gives the bit position in the loaded address or data.

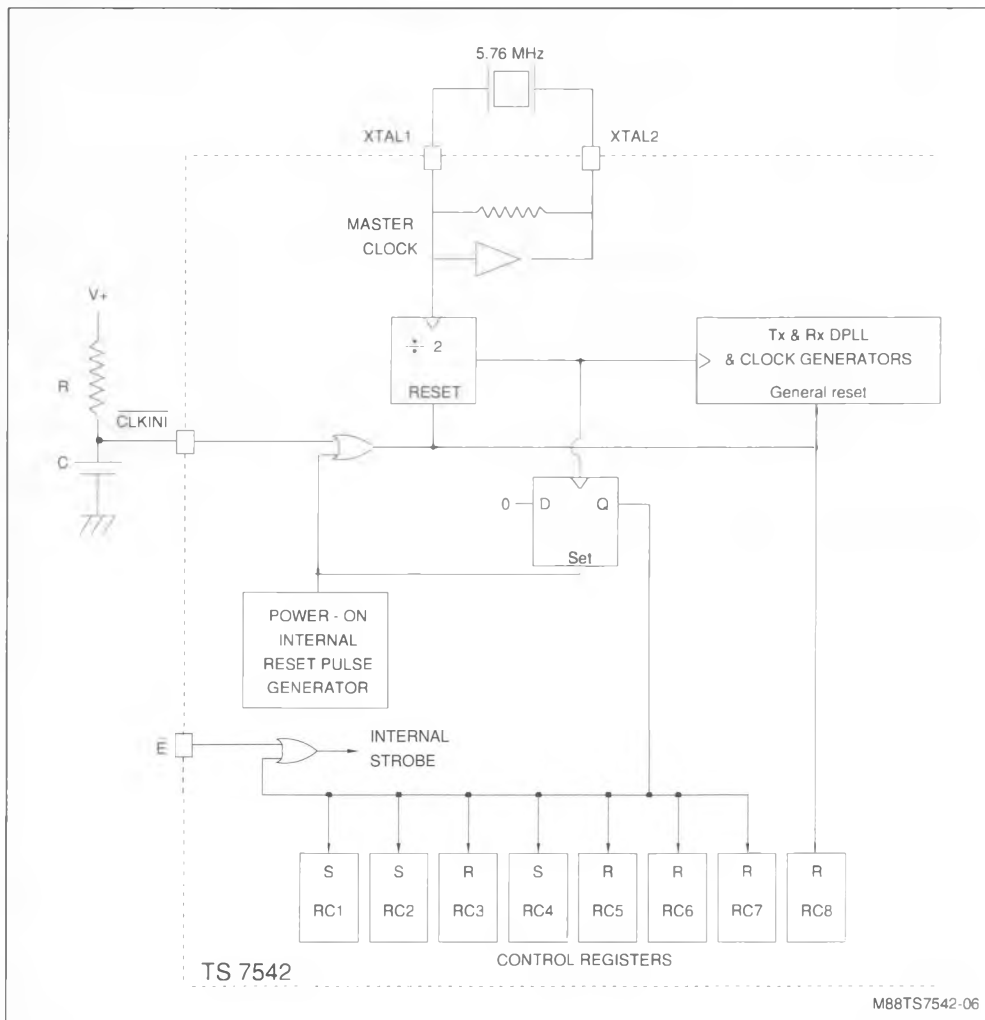
POWER-ON INITIALIZATION

Internal power-on circuitry (Fig.4) automatically resets the DPLL and the clock generators counters, and initializes the RC1 to RC8 control registers. The initial status of these registers are given in the PROGRAMMABLE FUNCTIONS section. The transmit attenuator is initialized to an infinite attenuation in order to avoid the transmission of undesirable signals on the phone line.

Access to the control registers is disabled during power-on reset until the clock oscillator starting. The

reset time duration can be increased by connecting the CLKINI input to an external RC timer as indicated in Fig.4. That feature will prevent, in particular applications, possible problems due to incontrolled signals coming from the DSP during power-on. In normal operation the CLKINI input can be used to reset the DPLL and clock generator counters and the RC8 control register. When that pin as not used, it must be tied to V^+

Figure 4 : Power-on Initialization Circuitry.

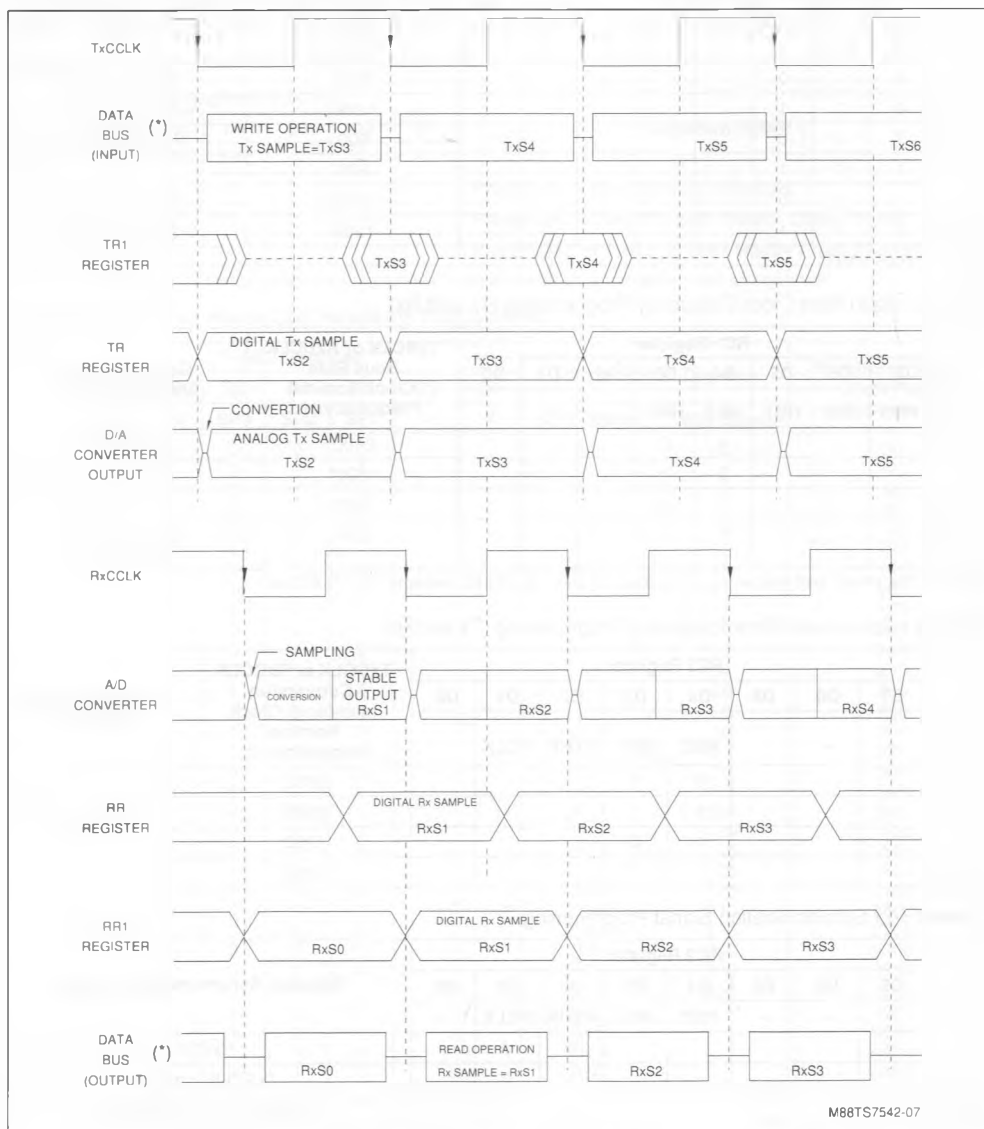


PROGRESSION OF SIGNAL SAMPLES

Fig.5 shows the progression in the TS7542 of the digital and analog signal samples. It appears that the transfers of the data representing the transmit and the receive signals have to be synchronized on

the TxCLK or the RxCLK conversion clock, respectively. This is the reason why the DSP needs to receive these clock signals or to read their status from the dedicated registers.

Figure 5 : Digital and Analog Samples Progress.



Notes : Txi = i th analog or digital sample of the Tx signal

Rxi = i th analog or digital sample of the Rx signal

(*) Data can be written (read) six master clock periods after the $Tx\ CCLK$ ($Rx\ CCLK$) negative-going transition respectively

PROGRAMMABLE FUNCTIONS

Table 4 : Bit Clock Frequency Programming (Tx and Rx).

	RC1 Register								TxCLK or RxCLK Bit Clock Nominal Frequency (Hz)	Communication Standard
	D7	D6	D5	D4	D3	D2	D1	D0		
	HB3	HB2	HB1	HR2	HR1	—	—	—		
	0	0	0						9600	V.29
	0	0	1						4800	V.27
	0	1	0						2400	V.22 bis, V.26
	0	1	1						1200	V.22, BELL 212A
	1	0	0						600	V.22 Fall-back
	1	0	1						600	"
	1	1	0						2400	V.22 bis, V.26
P/O	1	1	1						1200	V.22, BELL 212A

P/O : Power on status.

Table 5 : Baud Rate Clock Frequency Programming (Tx and Rx).

	RC1 Register								TxRCLK or RxBCLK Baud Rate Clock Nominal Frequency(Hz)	Communication Standard (note 3)
	D7	D6	D5	D4	D3	D2	D1	D0		
	HB3	HB2	HB1	HR2	HR1	—	—	—		
				0	0				2400	V.29, V.33
				0	1				1600*	V.27*
				1	0				1200	V.26
P/O				1	1				600	V.22, V.22 Bis, BELL 212A

Note 3 : The phase shift frequency of the transmit DPLL is 600 Hz, excepted for (*) 800 Hz.

Table 6 : Conversion Clock Frequency Programming (Tx and Rx).

	RC2 Register								TxCCLK or RxCLK Conversion (sampling) Clock Nominal Frequency(Hz)	Communication Standard
	D7	D6	D5	D4	D3	D2	D1	D0		
	—	—	—	HS2	HS1	HTHR	FCLK	—		
				0	0				9600	
				0	1				8000	V.27
				1	0				7200	
P/O				1	1				7200	

Table 7 : Tx Synchronization Signal Programming.

	RC2 Register								Selected Synchronisation Signal
	D7	D6	D5	D4	D3	D2	D1	D0	
	—	—	—	HS2	HS1	HTHR	FCLK	—	
						0	0		RxCLK
						1	0		TxSCLK (note 4)
P/O						X	1		Transmit DPLL free-runs

Note 4 : The Tx DPLL free runs if there is no transistion on this pin in that case
X = Don't care value

Table 8 : Tx Clock General Reset.

RC8 Register (note 5)								Resetting Transition
D7	D6	D5	D4	D3	D2	D1	D0	
MPE	SPR	AVRE	VAL	—	—	—	—	
1	0	0	0					Next Negative-going Transition of Synchronizing Signal

Note 5 : RC8 register is cleared after the programmed control operation is completed and on power-on.

Table 9 : Rx Clock Phase Shift Programming.

RC8 Register (note 5)							Action on Rx DPLL
D7	D6	D5	D4	D3	D2	D1	
MPE	SPR	AVRE	VAL	—	—	—	
0	1	0	0				Phase Lag of Programmed Amplitude
0	0	0	1				Phase Lag of Two 5.76 MHz Master Clock Periods
0	0	1	1				Phase Lead of Two 5.76 MHz Master Clock Periods

Note 5 : RC8 register is cleared after the programmed control operation is completed and on power-on.

Table 10 : Rx Clock Phase Shift Amplitude Programming.

	RC7 Register							Phase Shift in Degrees		Number of Master Clock Pulses Suppressed
	D7	D6	D5	D4	D3	D2	D1			
	SP5	SP4	SP3	SP2	SP1	—	—	1200 Bauds*	1600 Bauds	
	0	0	0	0	0			1.5	2	20
	0	0	0	0	1			3	4	40
	0	0	0	1	0			4.5	6	60
	0	0	0	1	1			6	8	80
	0	0	1	0	0			7.5	10	100
	0	0	1	0	1			9	12	120
	0	0	1	1	0			10.5	14	140
	0	0	1	1	1			12	16	160
	0	1	0	0	0			13.5	18	180
	0	1	0	0	1			15	20	200
	0	1	0	1	0			16.5	22	220
	0	1	0	1	1			18	24	240
	0	1	1	0	0			19.5	26	260
	0	1	1	0	1			21	28	280
	0	1	1	1	0			22.5	30	300
	0	1	1	1	1			24	32	320
	1	0	0	0	0			22.5	30	300
	1	0	0	0	1			45	60	600
	1	0	0	1	0			67.5	90	900
	1	0	0	1	1			90	120	1200
	1	0	1	0	0			112.5	150	1500
	1	0	1	0	1			135	180	1800
	1	0	1	1	0			157.5	210	2100
	1	0	1	1	1			180	240	2400
	1	1	0	0	0			202.5	270	2700
	1	1	0	0	1			225	300	3000
	1	1	0	1	0			247.5	330	3300
	1	1	0	1	1			270	360	3600
	1	1	1	0	0			292.5		3900
	1	1	1	0	1			315		4200
	1	1	1	1	0			337.5		4500
P/O	1	1	1	1	1			360		4800

(*) 2400 bauds : multiply by two. 600 bauds : divide by two.

Table 11 : Tx Attenuator Programming.

	RC4 Register								Attenuation (dB)
	D7	D6	D5	D4	D3	D2	D1	D0	
	ATT4	ATT3	ATT2	ATT1	–	EM2	EM1	–	
0	0	0	0	0					0
0	0	0	0	1					2
0	0	1	0						4
0	0	1	1						6
0	1	0	0						8
0	1	0	1						10
0	1	1	0						12
0	1	1	1						14
1	0	0	0						16
1	0	0	1						18
1	0	1	0						20
1	0	1	1						22
P/O	1	1	X	X					Infinite

X = Don't care value.

Table 12 : EXI and AGC1 Inputs Programming.

	RC4 Register								EXI Input Status	AGC1 Input Status
	D7	D6	D5	D4	D3	D2	D1	D0		
	ATT4	ATT3	ATT2	ATT1	–	EM2	EM1	–		
						0	0		Disabled	Tied to AGC Amplifier Input
						0	1		Tied to Tx Filter Input	"
						1	0		Tied to Tx Attenuator Input	"
P/O						1	1		Disabled	Tied to A/DC Input

Table 13 : Rx Filter Programming.

	RC3 Register				Sampling (Fs) and Cut-off (Fc) Frequencies (note 6)				Communication Standard	See Figure N°
	D7	D6	D5	D4	Low Pass Section		High Pass Section			
	RF3	RF2	RF1	RF0	Fs(kHz)	Fc(Hz)	Fs(kHz)	Fc(Hz)		
P/O	0	0	0	X	288	3200	144	1820	V.22, V.22 bis, BELL 212A and BELL 103 High Channels	7
	0	0	1	X	192	2133	115.2	1456	V.21 High Channel	8
	0	1	0	X	288	3200	82.3	1040	V.27 ter 2400 bps	9
	0	1	1	X	288	3200	72	910	V.27 ter 4800 bps, V.23, V.26 and BELL 202	10
	1	0	0	0	144	1600	64	809	V.22, V.22 bis, .BELL 212A and BELL 103 Low Channels	11
	1	0	0	1	144	1600	64	809	V.22, V.22 bis Low Channels with 1800 Hz Tone Rejection (*)	12
	1	0	1	X	115.2	1280	64	809	V.21 Low Channel	13
	1	1	0	X	288	3200	36	455	V.29, V.33	14
	1	1	1	X	288	3200	18	228	Full Channel Bandwidth	15
	1	1	1	X	48	533	27.4	347	75 bps Back Channel	16

(*) In this mode the 1800 Hz notch filter section is enabled.

X = Don't care values. The notch section is disabled in all these cases

Note 6 : The sampling clocks used by the Rx switched capacitor filters are straightly derived from the crystal oscillator. The Tx switched capacitor filter is driven from the Tx DPLL.**Table 14.**

	RC3 Register								Rx Filter Gain (dB)
	D7	D6	D5	D4	D3	D2	D1	D0	
	RF3	RF2	RF1	RF0	RFG2	RFG1	LAT2	LAT1	
P/O					0	0			0
					0	1			3
					1	0			6
					1	1			9

Table 15 : Line Output Attenuator Programming.

	RC3 Register								LAO Output Attenuation (dB)
	D7	D6	D5	D4	D3	D2	D1	D0	
	RF3	RF2	RF1	RF0	RFG2	RFG1	LAT2	LAT1	
P/O							0	0	Infinite
							0	1	0
							1	0	6
							1	1	12

Table 16 : Carrier Level Detector Programming.

	RC6 Register								Carrier Level Detector Threshold(dBm) (note 7)
	D7	D6	D5	D4	D3	D2	D1	D0	
	CDG2	CDG1	CDH	–	–	–	–	–	
P/O	0	0	0						– 29.85
	0	0	1						– 27.35
	0	1	0						– 36.65
	0	1	1						– 34.15
	1	0	0						– 46.75
	1	0	1						– 44.25
	1	1	0						– 46.75
	1	1	1						– 44.25

Note 7 : These values applies when the total Rx gain from the phone line to the Rx filter output is 0 dB.

Table 17 : AGC Amplifier Gain Programming.

	RC5 Register					AGC Amplifier Gain (dB)	
	D7	D6	D5	D4	D3	AGC1 Input	AGC2 Input
	RG5	RG4	RG3	RG2	RG1		
P/O	0	0	0	0	0	0	- ∞
	0	0	0	0	1		1.5
	- ∞	0	0	0	1	0	3
	- ∞	0	0	0	1	1	4.5
	- ∞	0	0	1	0	0	6
	- ∞	0	0	1	0	1	7.5
	- ∞	0	0	1	1	0	9
	- ∞	0	0	1	1	1	10.5
	- ∞	0	1	0	0	0	12
	- ∞	0	1	0	0	1	13.5
	- ∞	0	1	0	1	0	15
	- ∞	0	1	0	1	1	16.5
	- ∞	0	1	1	0	0	18
	- ∞	0	1	1	0	1	19.5
	- ∞	0	1	1	1	0	21
	- ∞	0	1	1	1	1	22.5
	- ∞	1	0	0	0	0	24
	- 14.5	1	0	0	0	1	25.5
	- 7.7	1	0	0	1	0	27
	- 3.4	1	0	0	1	1	28.5
	0	1	0	1	0	0	30
	2.7	1	0	1	0	1	31.5
	5.2	1	0	1	1	0	33
	7.4	1	0	1	1	1	34.5
	9.5	1	1	0	0	0	36
	11.4	1	1	0	0	1	37.5
	13.3	1	1	0	1	0	39
	15.1	1	1	0	1	1	40.5
	16.8	1	1	1	0	0	42
	18.5	1	1	1	0	1	43.5
	20.2	1	1	1	1	0	45
	21.8	1	1	1	1	1	46.5

ELECTRICAL SPECIFICATIONS

Unless otherwise noted, electrical characteristics are specified over the operating range. Typical values are given for $V^+ = +5\text{ V}$, $V^- = -5\text{ V}$ and $t_{\text{amb}} = 25\text{ }^{\circ}\text{C}$.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
	DGND Digital Ground to AGND Analog Ground	-0.3 to $+0.3$	V
	V^+ Supply Voltage to DGND or AGND Ground	-0.3 to $+7$	V
	V^- Supply Voltage to DGND or AGND Ground	-7 to $+0.3$	V
V_I	Voltage at any Digital Input or Output	DGND -0.3 to $V^+ + 0.3$	V
I_I	Digital Output Current	-20 to $+20$	mA
V_{in}	Voltage at any Input or Output	$V^- - 0.3$ to $V^+ + 0.3$	V
I_{out}	Analog Output Current	-10 to $+10$	mA
P_{tot}	Power Dissipation	500	mW
t_{amb}	Operating Temperature Range	0 to $+70$	$^{\circ}\text{C}$
t_{stat}	Storage Temperature Range	-65 to $+150$	$^{\circ}\text{C}$
t_{sold}	Pin Temperature (soldering 10 s.)	$+260$	$^{\circ}\text{C}$

POWER SUPPLIES

DGND = AGND = 0 V

Symbol	Parameter	Min.	Typ.	Max.	Unit
V^+	Positive Power Supply	4.75		5.25	V
V^-	Negative Power Supply	-5.25		-4.75	V
I^+	Positive Supply Current (receive signal level 0 dBm)			35	mA
I^-	Negative Supply Current (receive signal level 0 dBm)	-35			mA

DIGITAL INTERFACE

Control Inputs, Data Bus and Clock Outputs. Voltages referenced to DGND = 0 V

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IL}	Low Level Input Voltage			0.8	V
V_{IH}	High Level Input Voltage	2.2			V
I_{IL}	Low Level Input Current $\text{DGND} < V_I < 0.8\text{ V}$	-10		10	μA
I_{IH}	High Level Input Current $2.2\text{ V} < V_I < V^+$	-10		10	μA
V_{OL}	Low Level Output Voltage ($I_{OL} = 2.5\text{ mA}$)			0.4	V
V_{OH}	High Level Output Voltage ($I_{OH} = -2.5\text{ mA}$)	2.4			V
I_{OZ}	High Impedance Output Current (when E is high and $\text{DGND} < V_O < V^+$)	-50		50	μA

Crystal Oscillator Interface (XTAL1 input)

V_{IL}	Low Level Input Voltage			1.5	V
V_{IH}	High Level Input Voltage	3.5			V
I_{IL}	Low Level Input current $\text{DGND} \leq V_I \leq V_{IL\text{max}}$	-15			μA
I_{IH}	High Level Input Current $V_{IH\text{min}} \leq V_I \leq V^+$			15	μA

ELECTRICAL SPECIFICATIONS (continued)

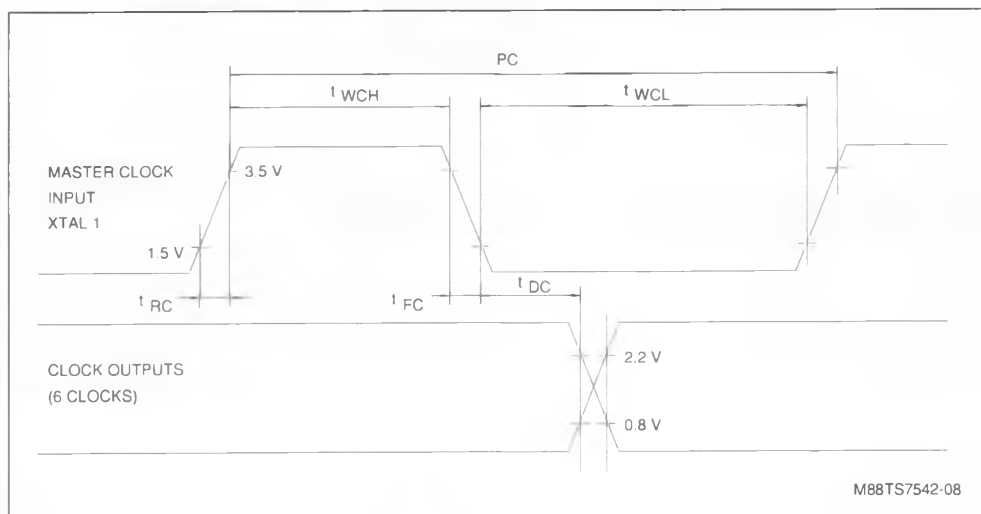
ANALOG INTERFACE All voltages referenced to AGND = 0 V

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{in}	Input Voltage EXI, Dxl, RAl	- 2.5		2.5	V
I_{in}	Input Current EXI, Dxl, RAl ($- 2.5 \text{ V} < V_{in} < 2.5 \text{ V}$)	- 1		1	μA
R_{in}	Input Resistance AGC1, AGC2	1.5			$\text{k}\Omega$
R_{in}	Input Resistance CD1	0.7			$\text{k}\Omega$
V_{out}	Output Voltage ATO, LAO, RFO $R_L = 1 \text{ k}\Omega$, $C_L = 50 \text{ pF}$	- 2.5		2.5	V
R_{out}	Output Resistance ATO LAO RFO			4 50 15	Ω
R_L	Load Resistance ATO, RFO	1			$\text{k}\Omega$
C_L	Load Capacitance ATO, RFO			50	pF
R_L	Load Resistance LAO	10			$\text{k}\Omega$
C_L	Load Capacitance LAO			20	pF

TIMING SPECIFICATIONS

TIMING SPECIFICATIONS Clock Timing Characteristics (XTAL1 input)

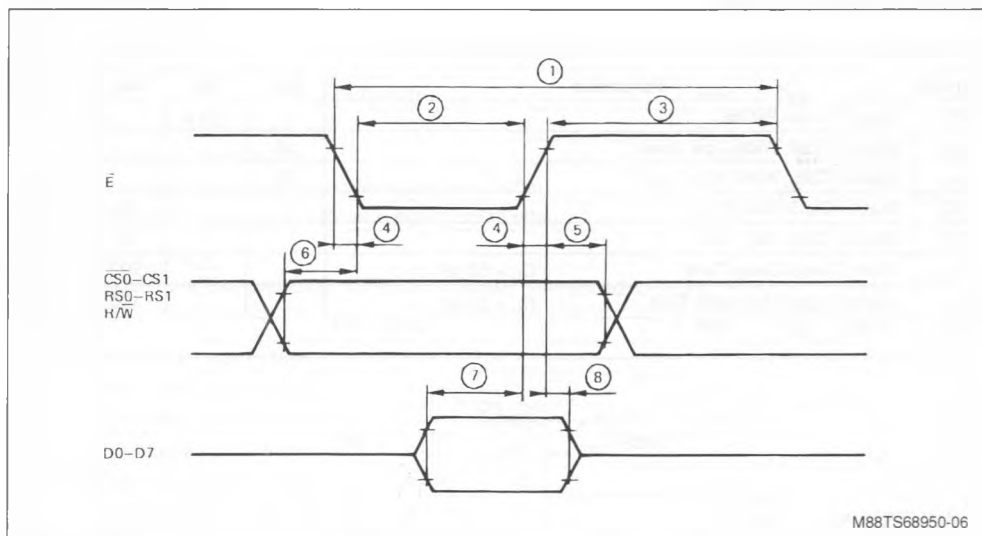
Symbol	Parameter	Min.	Typ.	Max.	Unit
PC	Master Clock Period		173.6		ns
t_{WCL}	Master Clock Width Low Level	50			ns
t_{WCH}	Master Clock Width High Level	50			ns
t_{RC}	Master Clock Rise Time			50	ns
t_{FC}	Master Clock Fall Time			50	ns
t_{DC}	Clock Output Delay Time $C_L = 50 \text{ pF}$			500	ns
t_{TC}	Clock Output Transition Time $C_L = 50 \text{ pF}$			100	ns



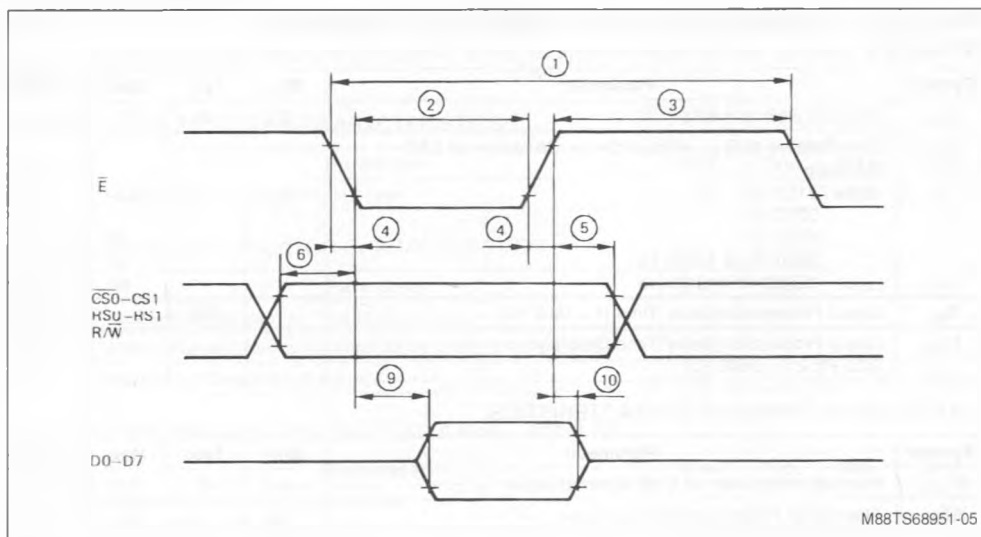
ELECTRICAL SPECIFICATIONS (continued)

BUS TIMING CHARACTERISTICS (see foot notes 1 and 2 on timing diagrams)

Symbol	Parameter	Min.	Typ.	Max.	Unit
t_{CYC}	Cycle Time (1)	320			ns
t_{WEL}	Pulse Width $\bar{E}$ Low Level (2)	180			ns
t_{WEH}	Pulse Width $\bar{E}$ High Level (3)	100			ns
t_r, t_f	Clock Rise and Fall Time (4)			20	ns
t_{HCE}	Control Signal Hold Time (5)	10			ns
t_{SCE}	Control Signal Set-up Time (6)	40			ns
t_{SDI}	Input Data Set-up Time (7)	120			ns
t_{HDI}	Input Data Hold Time (8)	10			ns
t_{SDO}	Output Data Set-up Time (1 TTL load and $C_L = 50$ pF) (9)			150	ns
t_{d2}	Output High Impedance Delay Time (1 TTL load and $C_L = 50$ pF) (10)			80	ns

WRITE OPERATION**Note 1 :** Voltage levels shown are $V_{IL} < 0.4$ V, $V_{IH} > 2.4$ V, unless otherwise specified**Note 2 :** Measurement points shown are 0.8 V and 2.2 V, unless otherwise specified

READ OPERATION



Note 1 : Voltage levels shown are $V_{IL} < 0.4 \text{ V}$, $V_{IH} > 2.4 \text{ V}$, unless otherwise specified.

Note 2 : Measurement points shown are 0.8 V and 2.2 V , unless otherwise specified.

TRANSMISSION CHARACTERISTICS

PERFORMANCES OF THE WHOLE TRANSMISSION CHAIN (Input TR1, Output ATO)

Symbol	Parameter	Min.	Typ.	Max.	Unit
G_{abs}	ATO Absolute Gain at 1 kHz	- 0.5	0	0.5	dB
N	ATO Psophometric Noise			100	μV
PSRR ⁺	ATO Positive Power Supply Rejection Ratio $V_{ac} = 200 \text{ mV}_{pp}$ $f = 1 \text{ kHz}$		40		dB
PSRR ⁻	ATO Negative Power Supply Rejection Ratio $V_{ac} = 200 \text{ mV}_{pp}$ $f = 1 \text{ kHz}$		40		dB
THD	Total Harmonic Distortion			- 54	dB

DAC TRANSFER CHARACTERISTICS

Symbol	Parameter	Min.	Typ.	Max.	Unit
	Converter Resolution		12		Bit
$V_{out(max)}$	Nominal Output Peak to Peak Amplitude		5.0		V
LSB	Least Significant Bit Amplitude		1.2		mV
E_{il}	Integral Linearity Error Relative to Best Fit Line		± 4	± 8	LSB
E_{dl}	Differential Linearity Error			± 0.7	LSB

TRANSMISSION CHARACTERISTICS

TRANSMIT FILTER TRANSFER CHARACTERISTICS (input EXI, output ATO)
(see figure 6)

Symbol	Parameter	Min.	Typ.	Max.	Unit
G_{abs}	Absolute Gain at 1 kHz	- 0.3	0	0.3	dB
G_{rel}	Gain Relative to G_{abs} without Sin x/x Correction of DAC Sampling Below 3100 Hz 3200 Hz 4000 Hz 5000 Hz to 12000 Hz 12000 Hz and Above	- 0.4 - 3		0.3 - 36 - 46 - 50	dB dB dB dB dB
T_{gp}	Group Propagation Delay Time ($f = 1800$ Hz)		250		μs
T_{gpd}	Group Propagation Delay Time Distortion (600 Hz < f < 3000 Hz)		430		

Tx ATTENUATOR TRANSFER CHARACTERISTICS

Symbol	Parameter	Min.	Typ.	Max.	Unit
AT_{abs}	Absolute Attenuation at 0 dB Nominal Value	- 0.3	0	0.3	dB
AT_{rel}	Attenuation Relative to Nominal Value	- 0.5		0.5	dB
AT_{max}	Maximum Attenuation	50			dB

RECEPTION CHARACTERISTICS

PERFORMANCE OF THE WHOLE RECEPTION CHAIN (input RAI or Dxl, output RR1)

Symbol	Parameter	Min.	Typ.	Max.	Unit
G_{abs}	Absolute Gain (AGC gain = 0 dB, RxCLK = 9600 Hz, $V_{in} = 775$ mVrms, $f = 2000$ Hz)	- 0.5	0	1.5	dB
HD_T	Total Harmonic Distortion (AGC gain = 0 dB, RxCLK = 9600 Hz, $V_{in} = 775$ mVrms, $f = 2000$ Hz, programmed band = 475 Hz - 3200 Hz)			- 54	dB
N	Equivalent RMS Noise (see note) (AGC gain = 0 dB, RAI, Dxl tied to AGND, frequency band = 228 Hz - 3200 Hz)			800	$\mu Vrms$

Note : Noise depends on AGC gain value.

RECEPTION CHARACTERISTICS (continued)**RECEIVE BAND-PASS FILTER AND REJECTION FILTER** (input RA1 or Dx1, output RFO)

The characteristics and specifications (templates) of the ten programmable transfer functions are given on figures 7 to 16.

RECEIVE FILTER INPUT GAIN CHARACTERISTICS

Symbol	Parameter	Min.	Typ.	Max.	Unit
G_{rel}	Relative Gain to Programmed Gain	- 0.5		0.5	dB

LINE MONITORING ATTENUATOR CHARACTERISTICS

Symbol	Parameter	Min.	Typ.	Max.	Unit
AT_{abs}	Absolute Attenuation at 0 dB Nominal Value	- 0.3	0	0.3	dB
AT_{rel}	Attenuation Relative to Nominal Value ($2\text{ dB} \leq AT \leq 22\text{ dB}$)	- 0.5		0.5	dB
AT_{max}	Maximum Attenuation ($AT = \infty$)	50			dB

AGC AMPLIFIER AND A/D CONVERTER (input AGC1, output RR1)

Symbol	Parameter	Min.	Typ.	Max.	Unit
G_{rel}	Relative Gain to Programmed Gain				
	$0\text{ dB} \leq AGC \leq 24\text{ dB}$	- 0.5		0.5	dB
	$25.5 \leq AGC \leq 46.5\text{ dB}$	- 1		1	dB
V_{os}	Offset Voltage	- 70		70	LSB

CARRIER LEVEL DETECTOR (input AGC1, output CDR)

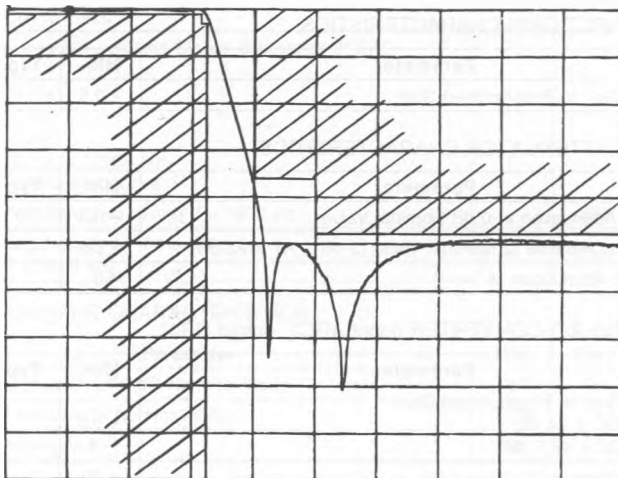
Symbol	Parameter	Min.	Typ.	Max.	Unit
T_{rel}	Relative Threshold to Programmed Value T				
	$- 36.65 < T \leq - 27.35\text{ dBm}$	0.5		0.5	dB
	$- 46.75 \leq T \leq - 36.65\text{ dBm}$	1		1	dB
H_{yst}	Hysteresis	2		3	dB
V_{os}	Input Offset Voltage				
	1st Threshold Pair (see table 16 and fig. 2)	- 1		1	mV
	2nd Threshold Pair	- 2		2	mV
	3rd Threshold Pair	- 3		3	mV
T_{dd}	Detection Delay Time 0 mVrms to 775 mVrms Transition or 775 mVrms to 0 mVrms Transition	1		3	ms

PERFORMANCE OF THE A/D CONVERTER (input AGC1, output RR1)

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{in(max)}$	Input Voltage (peak to peak)			5	V
R_{esh}	A/D Converter Resolution			12	Bit
LSB	Analog Increment		1.2		mV
E_{il}	Integral Linearity Error Relative to Best Fit Line		± 4	± 8	LSB
E_{dl}	Differential Linearity Error			± 0.7	LSB
V_{os}	Offset Voltage	- 100		100	LSB

Figure 6 : Tx Filter Frequency Response.

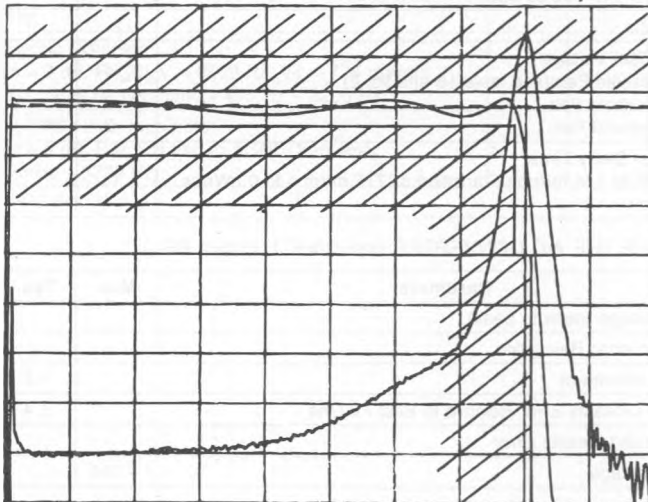
REF LEVEL	/DIV	MARKER 1	000.000Hz
0.000dB	10.000dB	MAG (UDF)	-0.150dB



START 0.000Hz
AMPTD 50.119mV

STOP 10 000.000Hz

REF LEVEL	/DIV	MARKER 1	000.000Hz
-0.150dB	1.000dB	MAG (UDF)	-0.157dB
400.00μSEC	100.00μSEC	MARKER 1	000.000Hz
		DELAY (A/R)	205.80μSEC



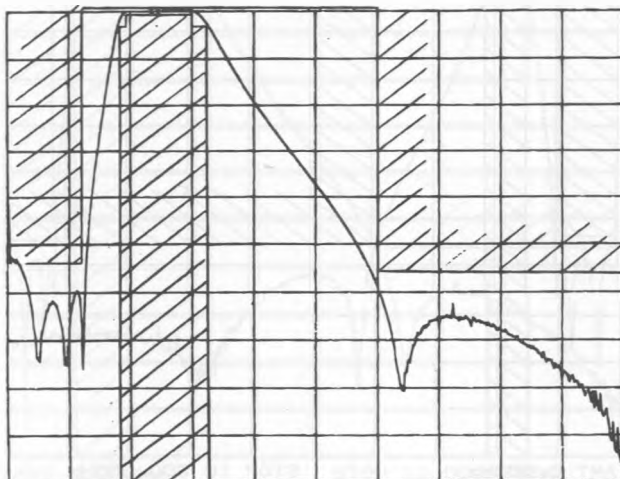
START 0.000Hz
AMPTD 50.119mV

STOP 4 000.000Hz
DELAY APER 20.00Hz

M88TS7542-09

Figure 7 : Rx Filter Frequency Response for V.22, V.22bis, BELL212A and BELL103 High Channels
(see table 13).

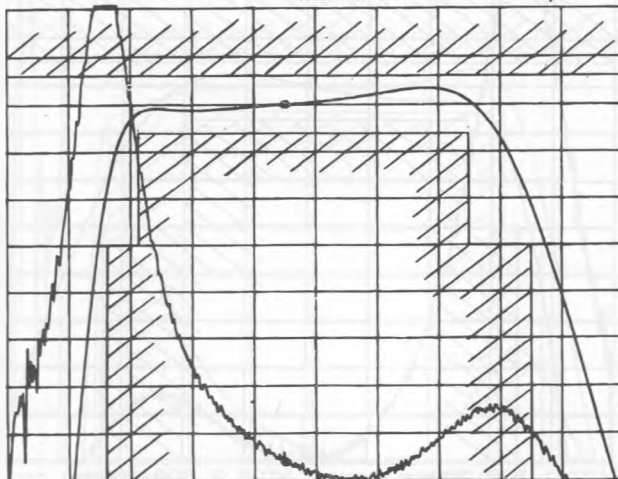
REF LEVEL	/DIV	MARKER 2	400.000Hz
0.000dB	10.000dB	MAG (A/R)	0.117dB



START 0.000Hz
AMPTD 199.53mV

STOP 10 000.000Hz

REF LEVEL	/DIV	MARKER 2	400.000Hz
0.129dB	1.000dB	MAG (A/R)	0.138dB
1.1350mSEC	100.00μSEC	MARKER 2	400.000Hz
		DELAY (A/R)	675.20μSEC



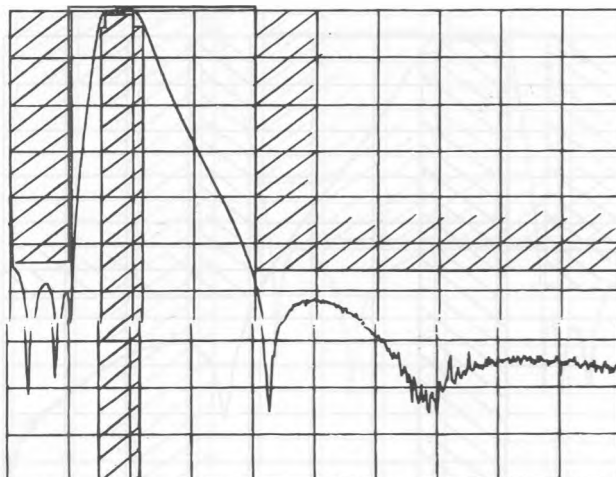
START 1 500.000Hz
AMPTD 100.00mV

STOP 3 500.000Hz

M88TS7542-10

Figure 8 : Rx Filter Frequency Response for V.21 High Channel (see table 13).

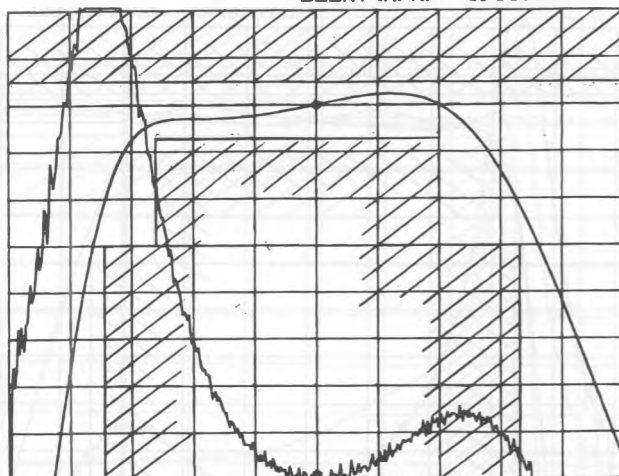
REF LEVEL	/DIV	MARKER 1	800.000Hz
0.000dB	10.000dB	MAG (A/R)	0.079dB



START 0.000Hz
AMPTD 199.53mV

STOP 10 000.000Hz

REF LEVEL	/DIV	MARKER 1	800.000Hz
0.100dB	1.000dB	MAG (A/R)	0.105dB
1.8000mSEC	100.00μSEC	MARKER 1	800.000Hz
		DELAY (A/R)	1.1109mSEC



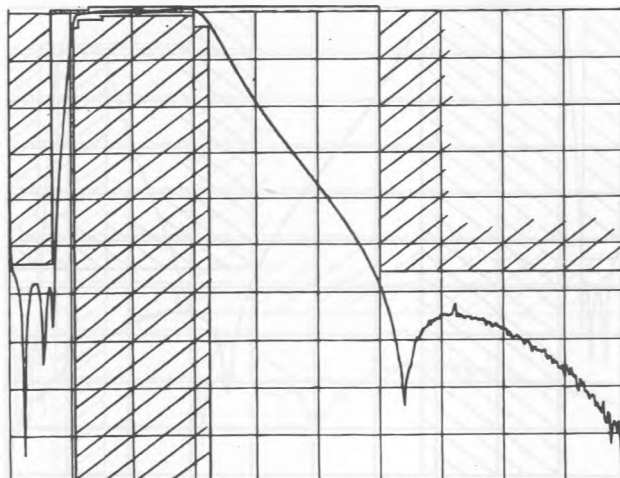
START 1 300.000Hz
AMPTD 100.00mV

STOP 2 300.000Hz

M88TS7542-11

Figure 9 : Rx Filter Frequency Response for V.27ter 2400bps (see table 13).

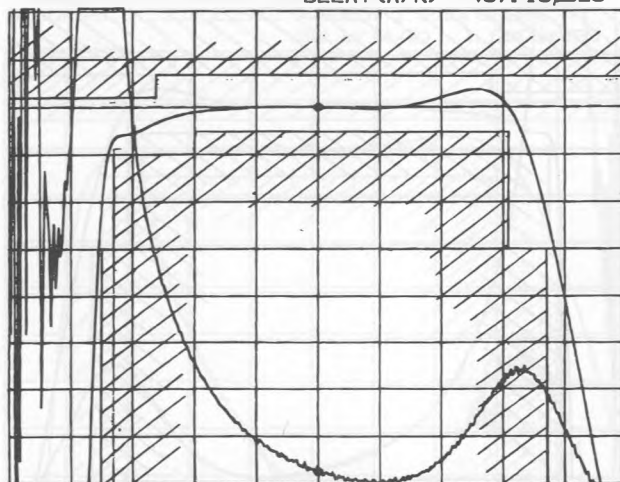
REF LEVEL	/DIV	MARKER 2	100.000Hz
0.000dB	10.000dB	MAG (A/R)	0.393dB



START 0.000Hz
AMPTD 199.53mV

STOP 10 000.000Hz

REF LEVEL	/DIV	MARKER 2	100.000Hz
0.380dB	1.000dB	MAG (A/R)	0.381dB
970.00μSEC	100.00μSEC	MARKER 2	100.000Hz
		DELAY (A/R)	497.19μSEC



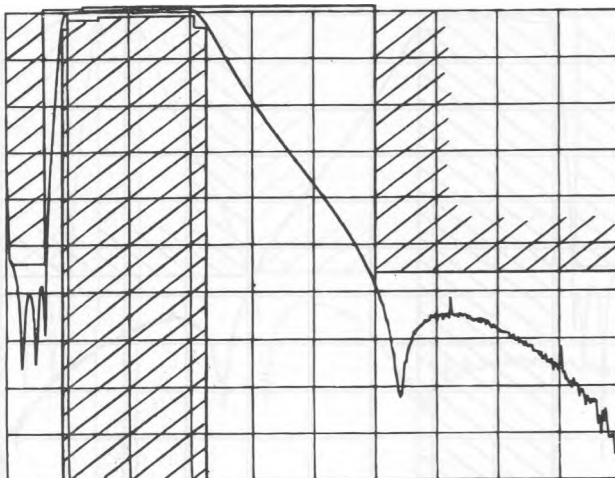
START 800.000Hz
AMPTD 100.00mV

STOP 9 800.000Hz

M88TS7542-12

Figure 10 : Rx Filter Frequency Response for V.27ter 4800bps, V.23, V.26 and BELL202 (see table 13).

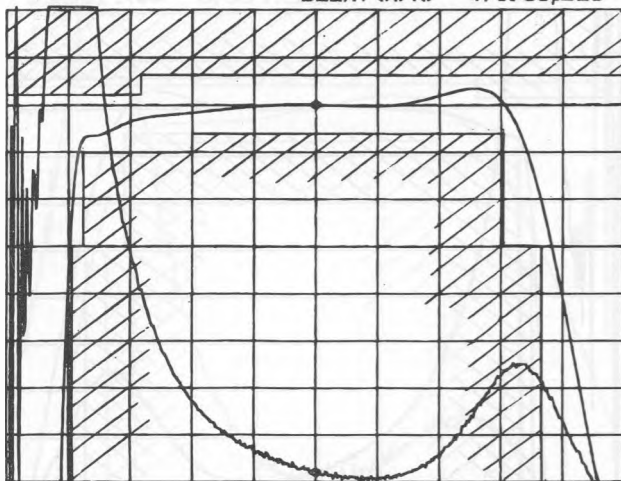
REF LEVEL	/DIV	MARKER 2	100.000Hz
0.000dB	10.000dB	MAG (A/R)	0.509dB



START 0.000Hz
AMPTD 199.59mV

STOP 10 000.000Hz

REF LEVEL	/DIV	MARKER 2	100.000Hz
0.490dB	1.000dB	MAG (A/R)	0.495dB
950.00μSEC	100.00μSEC	MARKER 2	100.000Hz
		DELAY (A/R)	471.00μSEC



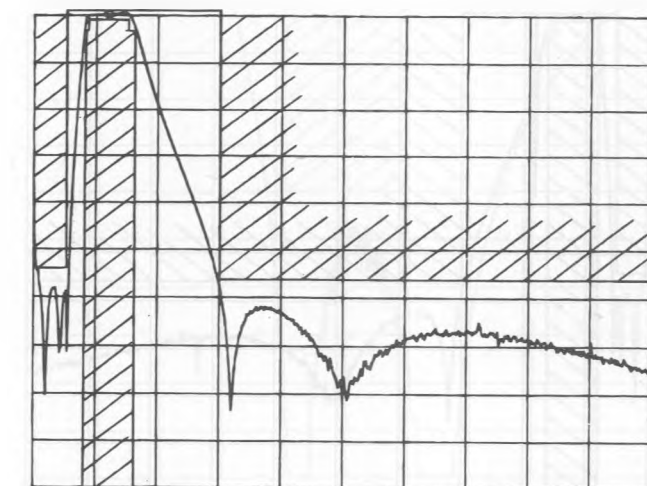
START 800.000Hz
AMPTD 100.00mV

STOP 3 800.000Hz

M88TS7542-13

Figure 11 : Rx Filter Frequency Response for V.22, V.22bis, BELL212A and BELL103 Low Channel (see table 13).

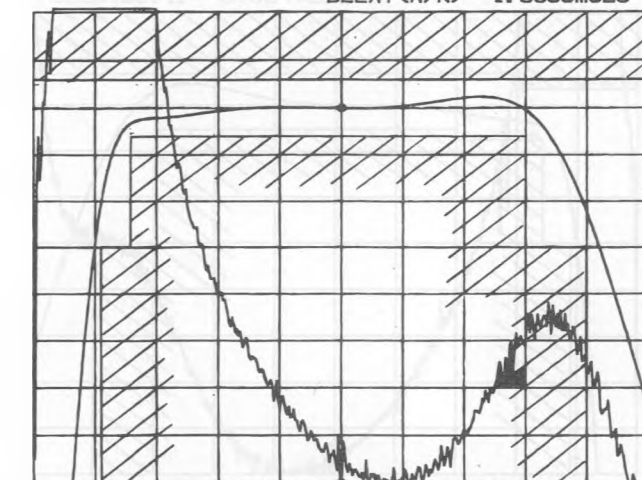
REF LEVEL /DIV MARKER 1 200.000Hz
0.000dB 10.000dB MAG (A/R) 0.220dB



START 0.000Hz
AMPTD 199.53mV

STOP 10.000.000Hz

REF LEVEL /DIV MARKER 1 200.000Hz
0.230dB 1.000dB MAG (A/R) 0.232dB
1.5600mSEC 100.00μSEC MARKER 1 200.000Hz
 DELAY (A/R) 1.0605mSEC



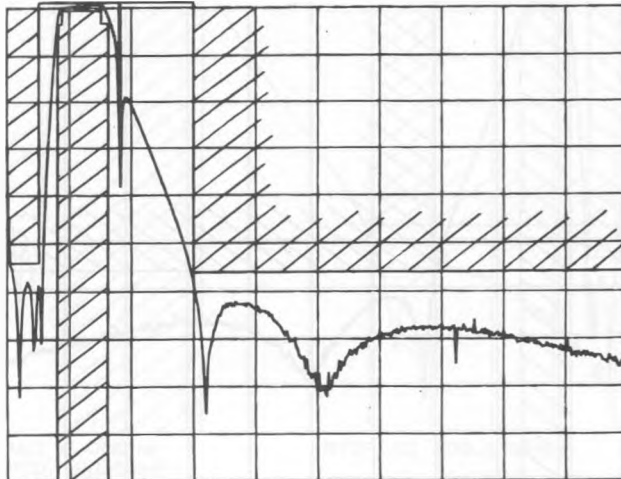
START 700.000Hz
AMPTD 100.00mV

STOP 1 700.000Hz
DELAY APER 5.000Hz

M88TS7542-14

Figure 12 : Rx Filter Frequency Response for V.22 and V.22bis Low Channels with 1800Hz Tone Rejection (see table 13).

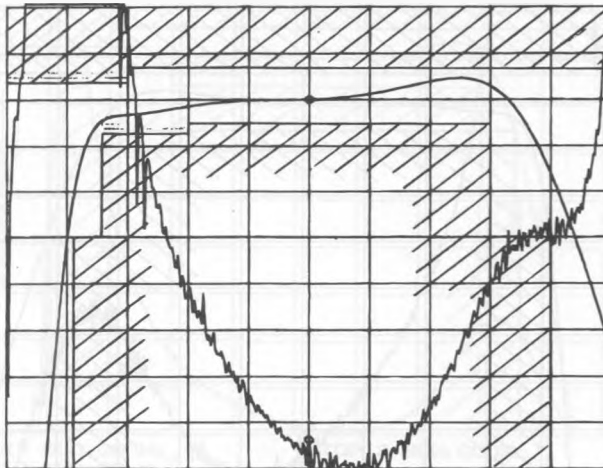
REF LEVEL	/DIV	MARKER 1	200.000Hz
0.000dB	10.000dB	MAG (A/R)	0.423dB



START 0.000Hz
AMPTD 199.53mV

STOP 10.000.000Hz

REF LEVEL	/DIV	MARKER 1	200.000Hz
0.430dB	1.000dB	MAG (A/R)	0.439dB
1.6250mSEC	100.00μSEC	MARKER 1	200.000Hz
		DELAY (A/R)	1.1887mSEC



START 700.000Hz
AMPTD 100.00mV

STOP 1.700.000Hz

M88TS7542-15

Figure 12 (continued) : Rx Filter Frequency Response for V.22 and V.22bis Low Channels with 1800Hz Tone Rejection (see table 13).

REF LEVEL /DIV MARKER 1 800.000Hz
 -30.000dB 2.000dB MAG (A/R) -31.540dB

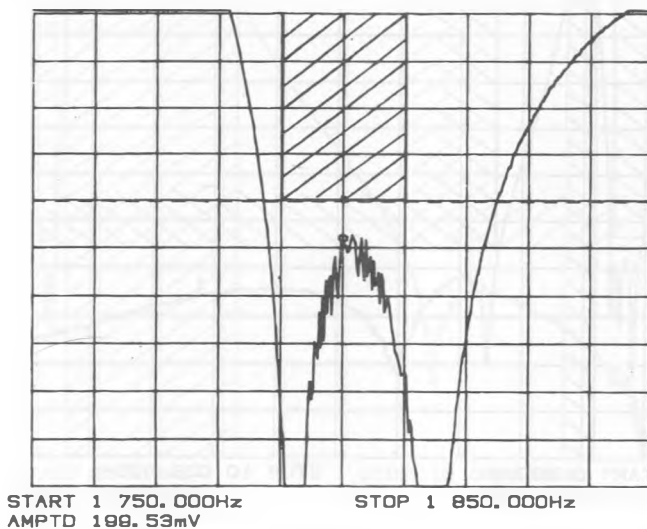
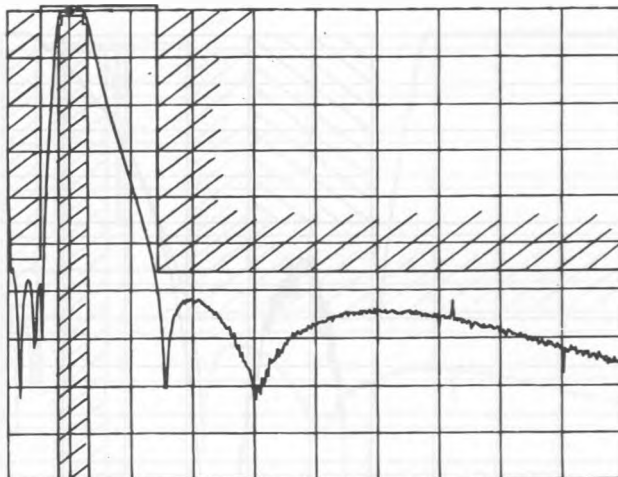


Figure 13 : Rx Filter Frequency Response for V.21 Low Channel (see table 13).

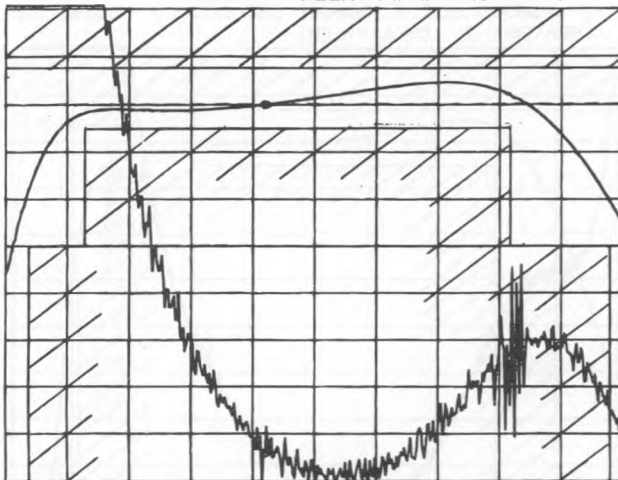
REF LEVEL	/DIV	MARKER 1	000.000Hz
0.000dB	10.000dB	MAG (A/R)	-0.039dB



START 0.000Hz
AMPTD 199.53mV

STOP 10.000.000Hz

REF LEVEL	/DIV	MARKER 1	000.000Hz
0.000dB	1.000dB	MAG (A/R)	0.004dB
2.1250mSEC	100.00μSEC	MARKER 1	000.000Hz
		DELAY (A/R)	1.6848mSEC



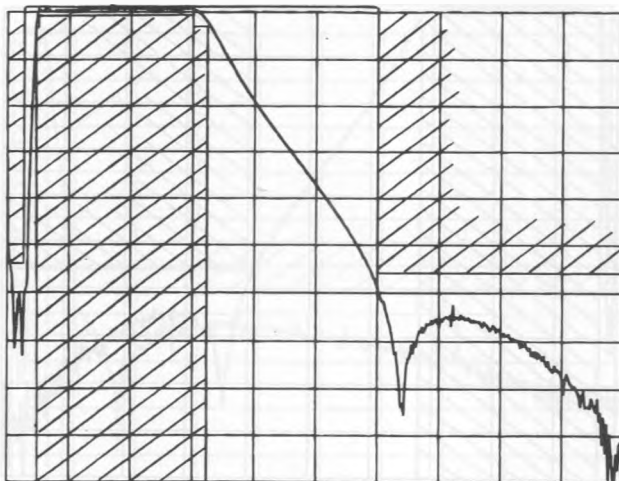
START 790.000Hz
AMPTD 100.00mV

STOP 1.290.000Hz

M88TS7542-16

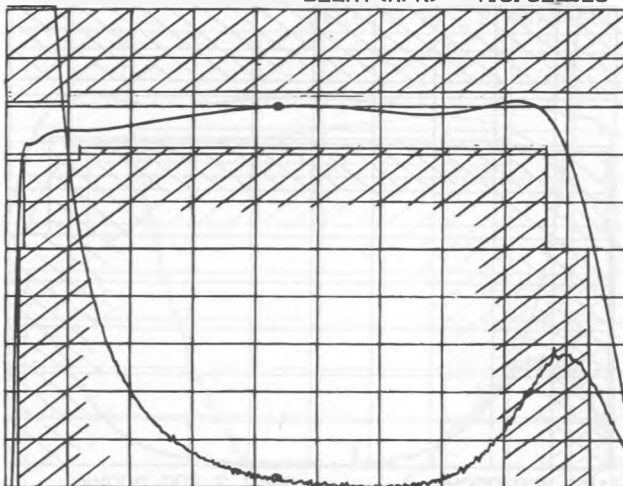
Figure 14 : Rx Filter Frequency Response for V.29 and V.33 (see table 13).

REF LEVEL	/DIV	MARKER 1	700.000Hz
0.000dB	10.000dB	MAG (A/R)	0.749dB



START	0.000Hz	STOP	10 000.000Hz
AMPTD	199.53mV		

REF LEVEL	/DIV	MARKER 1	705.000Hz
0.725dB	1.000dB	MAG (A/R)	0.731dB
895.00μSEC	100.00μSEC	MARKER 1	705.000Hz
		DELAY (A/R)	418.82μSEC

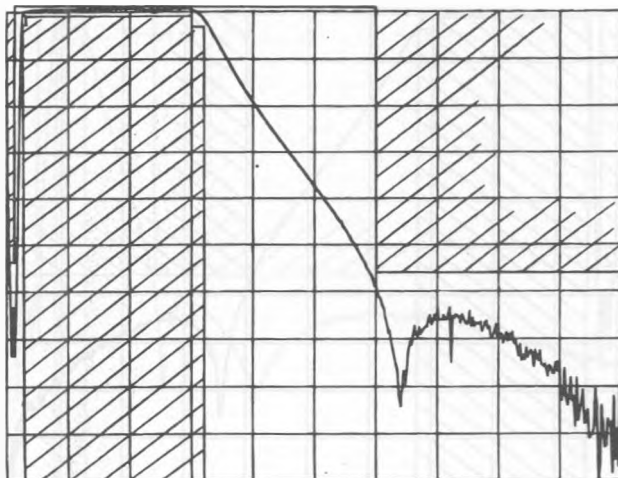


START	400.000Hz	STOP	3 400.000Hz
AMPTD	100.00mV		

M88TS7542-17

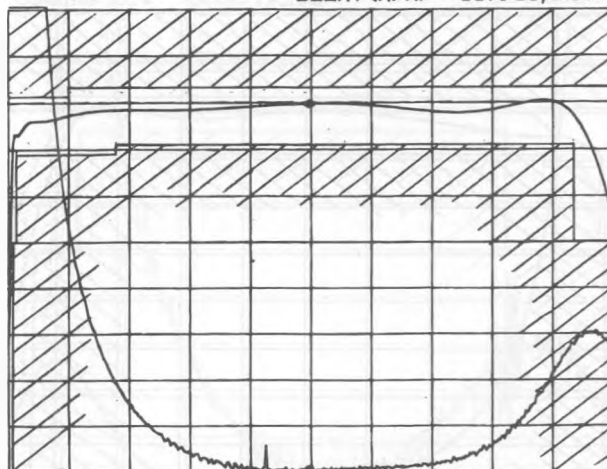
Figure 15 : Rx Filter Frequency Response with Full Channel Bandwidth (see table 13).

REF LEVEL	/DIV	MARKER 2	400.000Hz
0.000dB	10.000dB	MAG (A/R)	0.494dB



START	0.000Hz	STOP	10 000.000Hz
AMPTD	100.00mV		

REF LEVEL	/DIV	MARKER 1	702.550Hz
0.700dB	1.000dB	MAG (A/R)	0.892dB
980.00μSEC	100.00μSEC	MARKER 1	702.550Hz
		DELAY (A/R)	367.39μSEC

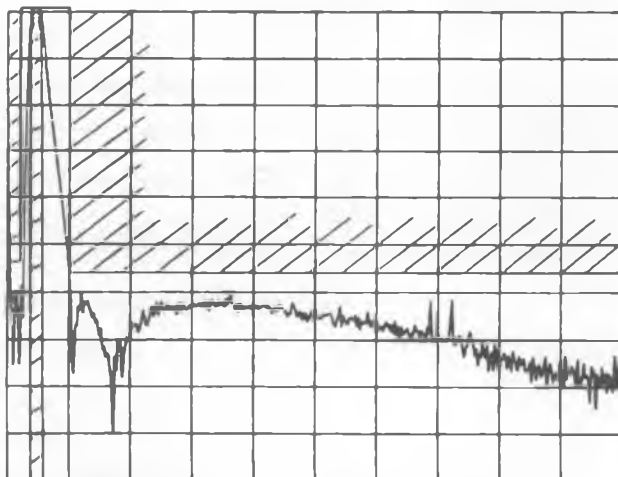


START	220.000Hz	STOP	3 200.000Hz
AMPTD	100.00mV		

M88TS7542-18

Figure 16 : Rx Filter Frequency Response for 75bps Back Channel (see table 13).

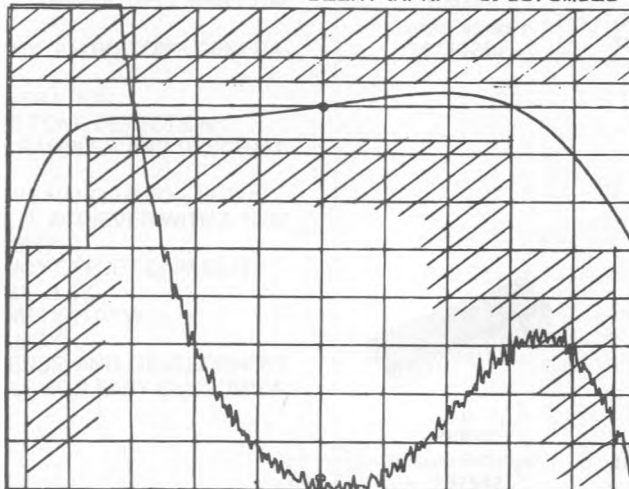
REF LEVEL	/DIV	MARKER	450.000Hz
0.000dB	10.000dB	MAG (A/R)	0.090dB



START 0.000Hz
AMPTD 100.00mV

STOP 10 000.000Hz

REF LEVEL	/DIV	MARKER	440.000Hz
0.200dB	1.000dB	MAG (A/R)	0.197dB
4.8450mSEC	200.00μSEC	MARKER	440.000Hz
		DELAY (A/R)	3.9978mSEC



START 340.000Hz
AMPTD 100.00mV

STOP 540.000Hz

M88TS7542-19